

**SIX
\$500
SCHOLARSHIPS
AVAILABLE**



2023

College Scholarship Application

REV 02072023
This institution is an equal opportunity provider and employer.





2023 College Scholarship Application

About This Scholarship

The Valley FiberCom Scholarship was established in 2019. Valley FiberCom’s parent company, Valley Telecommunications, has a long established history of supporting our local communities and those that live within the communities - including our area students and future leaders. To date, nearly \$100,000 in Scholarship Awards have been presented.

Eligibility

- Applicant is currently a high school senior graduating in 2023.
- Applicant must enroll in a full-time undergraduate course of study no later than the fall term of the 2023-2024 school year at an accredited two- or four-year college, university, or vocational-technical school within the United States.
- Applicant must reside with a Parent/Legal Guardian within the Valley FiberCom Service Area. Valley FiberCom serves the following communities: Arlington, SD; De Smet, SD; Lake Preston, SD; Volga, SD, rural Flandreau, SD; and rural Colman/Egan, SD.
- Applicant may only apply for ONE Valley FiberCom Scholarship Award.

Immediate family members of Valley FiberCom employees and/or directors are not eligible.

How to Apply

- Applicant must complete the attached application and questionnaire. Typed responses are required. (An additional page may be used if needed.) Incomplete or late applications will not be considered.
- Applicant must complete the 500 word essay portion of the questionnaire. (Question 5 on the application).
- Applicant must complete the Consent and Release Form included with this application.
- Applicant must include a yearbook style photo for publication. This must be a high-resolution photo (300 dpi minimum). **No Copies or Scans will be accepted.**
- Application must be signed by the applicant’s High School Guidance Counselor or Principal. This school official must also provide GPA, Class Rank Information, and Official Transcript. The **Official School Stamp Is Required.**
References will not be accepted.

Award Procedure

- Six (6) \$500 Scholarship will be awarded to deserving applicants, one in each exchange.
- Scholarship winners will be selected by an independent third-party, and based on community involvement, school activities, essay responses, grade point average, and overall appearance of the application.
- Scholarships will be presented at each School’s Academic Awards Program or Graduation Ceremony, at the schools request.
- Scholarship will apply towards the applicants second-semester tuition and will be mailed directly to the winning applicant after proof of enrollment is received by the Valley FiberCom office in January of the award year. Should the applicant’s enrollment status change, Valley FiberCom must be notified immediately to prevent jeopardizing the scholarship.

Scholarships will be awarded without regard to race, color, national origin, religion, sex, gender identity, sexual orientation, or disability.

Applications must be postmarked by April 3, 2023. Mail your application and supporting materials to:

**Valley FiberCom
Scholarship Applications
PO Box 7
Herreid, SD 57632-0007**

Questions? Call 1-866-45FIBER

Late applications will not be considered.



2023 College Scholarship Application

Applicant Information (to be completed by the applicant)

Name of Applicant: _____
(First) (Middle Initial) (Last)

Email Address: _____ Cell Phone #: _____

Name of Parent(s) or Guardian(s): _____

Home Phone #: _____ Parent/Guardian Email Address: _____
(If Applicable)

Mailing Address: _____
(City) (State) (Zip Code)

Name of High School Currently Attending: _____

Community Activities: _____

Name & Address of College, University, or Vocational/Technical School You Plan to Attend:

Intended Major, Program, or Area of Study:

Applicant Certification

I confirm that the information on this application is complete and correct to the best of my knowledge. I grant permission to Valley FiberCom to contact my school if necessary.

Signature of Applicant _____ Date _____

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Consent and Release Form

I hereby grant to Valley FiberCom, its advertising agency, licensees and producers or publishers of its promotional materials and their successors and assigns, the right to use, publish and copyright my picture, portrait and/or videotaped/filmed likeness, in whole or in part, including alterations, modifications, derivations and composites thereof, in advertising, promotion and social media of Valley FiberCom.

I waive any right to inspect and/or approve the finished product or advertising copy of the ad that may be used in conjunction with this image to the eventual use of that which it is applied.

I hereby warrant that I am of full age and competent to contract in my own name in so far as the above is concerned. I have read the foregoing release and warrant that I fully understand the contents thereof.

Please sign below to acknowledge your consent for photographic likeness to be used in printed publications, ads, brochures, or other published materials, and/or electronic marketing purposes.

Minors: If applicant is under 18 years of age, the minor’s parent or guardian must complete and sign the form and further agree:

I am the parent or guardian of the minor listed below. I have fully authority to authorize the above release, which I have read and approved. I hereby release and agree to indemnify the licensed parties and their respective successors and assigns, from and against any and all liability arising out of the exercise of the rights granted by the above release.

Full Name of Applicant (print): _____

Applicant Signature: _____

Signature of Parent/Guardian of Minor (if applicable): _____

Date: _____

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School Guidance Counselor or High School Principal Certification

Name of Applicant: _____

Applicant's GPA: _____

Applicant's Overall Class Rank: _____ of _____ students

I confirm that the information provided above, as part of the Valley FiberCom Scholarship, is true and correct to the best of my knowledge, as recorded in the student's permanent record on file.

Printed Name of School Official: _____

Title of School Official: _____

Signature of School Official: _____

Date: _____

**Official School Stamp is Required.
Official Student Transcript Must Be Attached.**



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Application Questionnaire

Please answer the following questions.
(A separate sheet of paper may be used.).
Please include each question along with your answer.
Typed responses are required.

1. What high school activities have you been involved with during your four years of high school?

2. What prompted you to select the College/University/Vocational-Technical School that you have chosen?

3. How has living in a rural area influenced your decision to further your education?

4. Why do you feel you are the best qualified applicant for the Valley FiberCom Scholarship?

5. How do you use technology in today's world and how do you see these advanced technology services evolving in the years to come?
Must be a minimum of 500 words.

Application Checklist

- Completed Application Form
- Completed Questionnaire
- Completed Consent & Release Form
- Year-Book Style Photo (high-resolution)
- Guidance Counselor/Principal Certification (must include official school stamp)
- Official School Transcript

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